Specifications Horticulture 3030 LEDs



Higher performing 3030 family LED with well known superior robustness, high reliability, long lifetime, low thermal resistance. Perfectly addressing applications demanding for high efficiency and long lifetime requirement. LEDs engineered to deliver the precise wavelengths of light needed to improve crop yield.

The 3030 Series is purpose-built to enable ease of system design for Horticulture applications. The 3030 Series offers the only LEDs available today that are binned and tested based on Photosynthetic Photon Flux (PPF).

Features:

- Package: white SMD package, colored diffused silicone resin.
- •package options 3.0mm x 3.2mm for design freedom.
- Viewing angle at 50 % IV: 120°
- •Color: 660 nm (Deep red)
- Product series and company logo on the front.
- RoHS compliant, lead free and REACH.
- LM 80

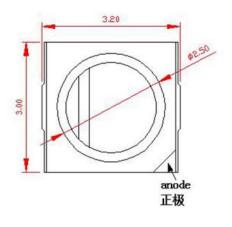
Applications:

• Horticulture

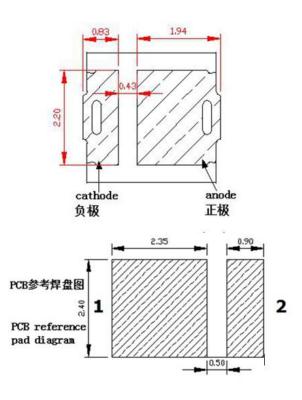
1. Performance Characteristics

1.1Product Information

TLS-P30YM-0101GA-R660A				
TLS: Product series	R660A: WP 660-665nm			
P30YM: SMD Type				
0101: Die Count In Serie and Parallel				
GA: Flux Level				



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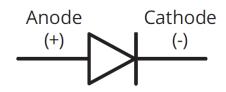


(+) (-)

Anode

Cathode

1.2 Mechanical Dimension



Notes:

- 1. All dimension tolerance is ± 0.2 mm unless otherwise noted.
- 2. Tc measurement point at anode pad of product.

2. Performance Characteristics

2.1 Product Selection Guide.

Table 1. Product performance of 3030 at 350mA, Tj=85°C.

		λ peal	<	PAR		PPF		PPE		YPF		YPE	
Part Number	Color	(nm)		(m W	')	(µ mol	/s)	(µ mol	/J)	(µ mol	/s)	(µ mol	(L\
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
TLS-P30YM-	DR	650	670	390	450	2.1	2.6	3.0	3.6	2.11	2.61	3.01	3.61
0101GA													

Notes for Tables

1. TYF maintains a tolerance of $\pm 8\%$ on μ mol/s for 3030 Horticulture.

2. PAR is the photosynthetic active radiation from 380 to 800nm.

3. PPF is the photosynthetic active radiation from 400 to 700nm.

4. Far Red typical PFFR and Par is measured from 700 to 800nm.

5. YPF is the photosynthetic active radiation from 380 to 800nm.

2.2 Optical Characteristics

Table 2. Optical characteristics for 3030 Series at specified test conditions

		TYPICAL	TYPICAL	Typical Total	Typical
Part Number	Color	SPECTRAL	TEMPERATURE	Included Angle	Viewing Angle
		HALF-WIDTH (nm)	WAVELENGTH (nm/°C)		
TLS-P30YM-	DR	20	0.06	150	120
0101GA					

Notes for Table 2:

1. Total angle at which 90% of total luminous flux is captured.

2. Viewing angle is the off ax is angle from lamp centerline where the luminous intensity is ½ of the peak value.

2.3 Electrical and Thermal Characteristics

Table 3: Electrical and thermal characteristics

		Forwa	Forward Voltage		Typical Temperature	Typical Thermal
Part Number	Part Number Color				Coefficient of	Resistance—Junction
	COIOI	Min	Туре	Max	Forward Voltage	Minimum Typical MAXIMUM to
					(mV/°C)	Solder Pad (°C/W)
TLS-P30YM-	DR	1.8	2.2	2.6	-1.7	10
0101GA						

Notes for Table 3:

1. TYF SMD3030 maintains a tolerance of $\pm 0.1V$ on forward voltage measurements.

2. Measured Tj=25°C.

3. Absolute Maximum Ratings

Table 4. Absolute maximum ratings

Parameter	Deep Red
DC Forward Current	500 mA
Peak Pulsed Forward Current	700 mA
Max Power	1.5W
LED Junction Temperature	125℃
ESD Sensitivity (ANSI/ESDA/JEDEC JS-001-2012)	Class 3B
Operating Case Temperature	-40~105°C
LED Storage Temperature	-40~115°C
Soldering Temperature	20°C to 260°C
Allowable Reflow Cycles	3
Reverse Voltage *4	-5
Reverse Current*4	5uA

Notes for Table 4:

- 1. Max power and positive current mean the maximum setting value of the bottom temperature of led light source by using the appropriate heat sink.
- Pulse operation with the maximum peak pulse forward current is acceptable if the pulse on time is ≤5ms per cycle and the duty cycle is ≤50%
- 3. In order to keep the Tj temperature below the rated, you should make sure that the radiator has enough heat dissipation performance. Measurement of Surface Temperature: TC on this point is shown in the figure below. The lifespan of the lamp can be judged according to the TC Temperature. Product data sheet is corresponding to the lifespan of TC temperature





 Connection error and off-limits voltage may damage LED chip. At a maximum reverse current of 10μA.SMD 3030 LEDs are not designed to be driven in reverse bias.

4. Reliability

Tab5.Testing items and testing conditions

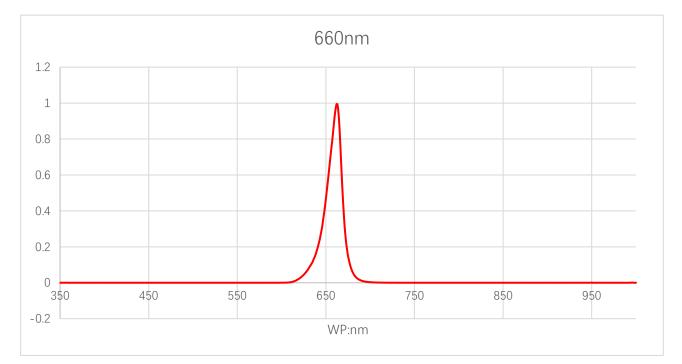
Serial No.	Test Item	reference standard	Test condition	Sample Quantity	Failure Quantity
1	Thermal shock	JESD22- A104E			0
2	High Temperature Storage	JESD22- A103D	+100°C,1000h	22pcs	0
3	Low Temperature Storage	JESD22-A119	-40°C,1000h	22pcs	0
4	Temperature, High Humidity, Aging Test	JESD22- A101C	,		0
5	High-temperature operation	IESLM80- 2015	T=+105°C,IF=500mA 6000h	22pcs	0
6	Low temperature operation	JESD22- A108D	T=-40°C,IF=500mA 1000h	22pcs	0
7	Moisture/Reflow Sensitivity Test	J-STD-020E	Precondition: 60°C.60%RH.168H Tsld=260°C. 10sec. 3 Reflows	22pcs	0

Tab6 Failure criteria

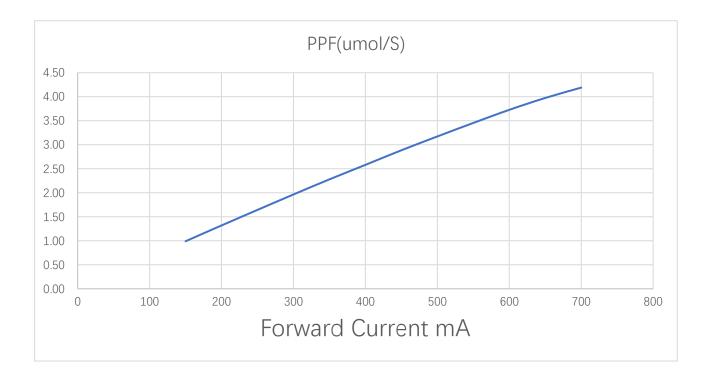
Test Items	Test Condition	Criteria for Judgement			
Test items	lest condition	Min.	Max.		
Forward Voltage	IF=350mA	/	U.S.L*) x1.1		
Reverse Current	=5V	/	U.S.L*) x2.0		
Luminous Flux	IF=350mA	L.S.L*) x0.7	/		

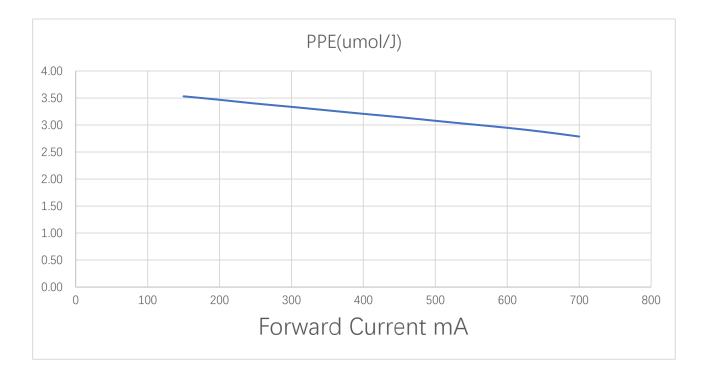
5. Characteristic Curves

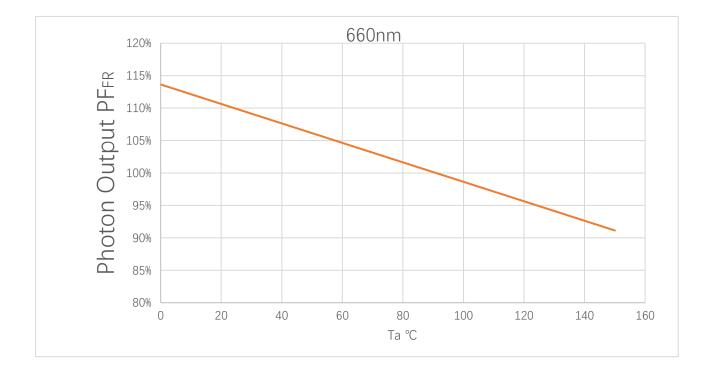
5.1 Spectral Power Distribution Characteristics



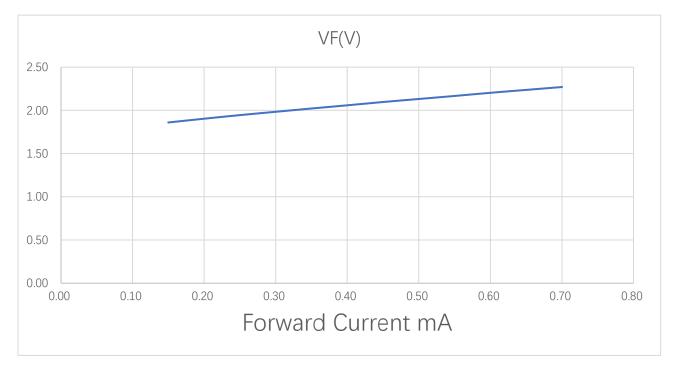
5.2 Photon Output Characteristics

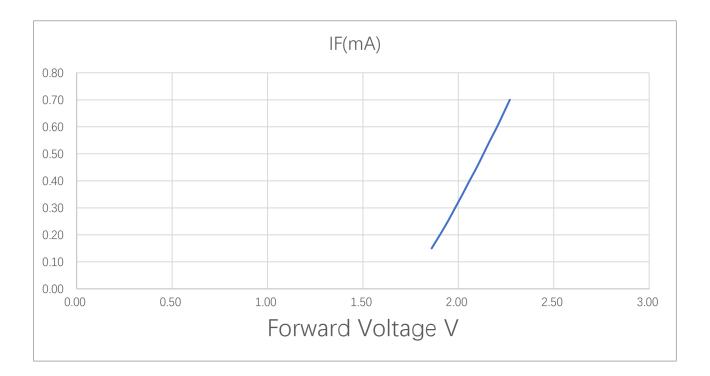




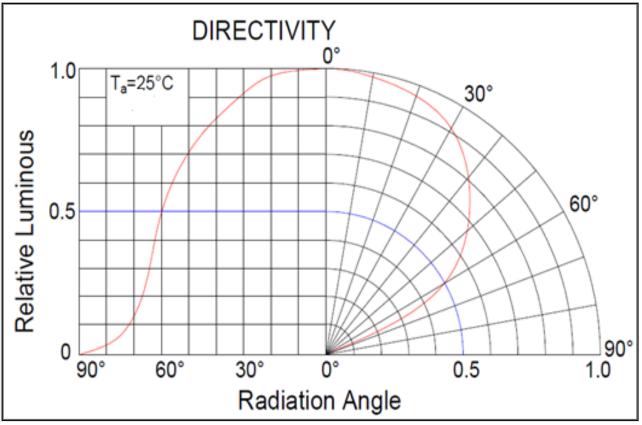








5.4 Radiation Pattern Characteristics



6. Product Bin and Labeling Definitions

6.1 PPF Bins

BIN	PPF			
DIIN	MIN	MAX		
L	2	2.25		
Μ	2.25	2.5		
Ν	2.5	2.75		

6.2 Forward Voltage Bins

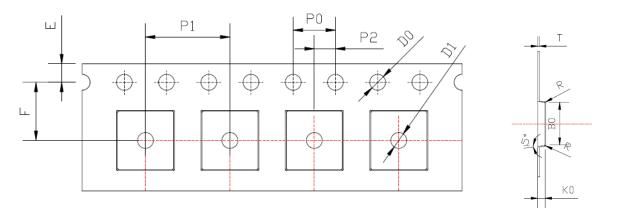
DIN	VF		
BIN	MIN	MAX	
F1	1.8	2.0	
G1	2.0	2.2	
H1	2.2	2.4	

6.3 Peak Wavelength Bins

Part Number	art Number Color	BIN	PEAK WAVELENG		
Part Nulliper	COIDI	DIN	MIN	MAX	
TLS-P30YM-	DR	10nm/Bin	655nm	670nm	
0101GA					

7. Packaging Information

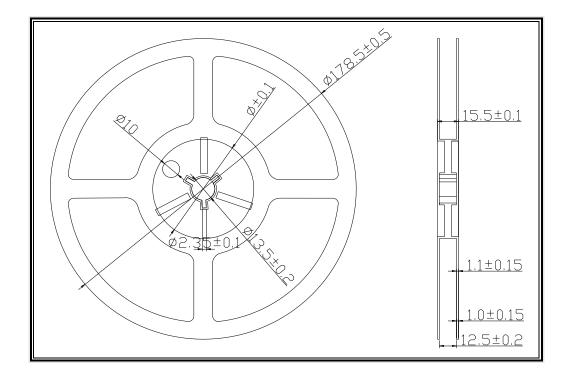
7.1 Pocket Tape Dimensions



Symbol	A0	В0	КО	P0	P1	P2
Spec	3.7±0.1	3.7±0.1	2.4±0.1	4±0.1	8±0.1	4±0.1
Symbol	W	т	E	F	D0	D1
Spec	12±0.1	0.3±0.1	1.75±0.1	5.5±0.1	1.6±0.1	1.6±0.1

7.2 Reel Dimensions

Each reel holds 1000pcs SMDs.

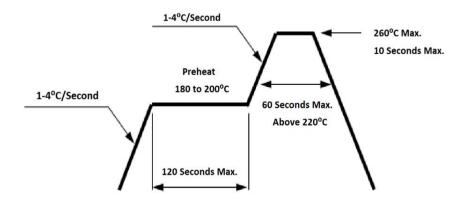


7.3 Product Packing and Labeling



8. CAUTION

8.1 RECOMMENDED SOLDERING CONDITION



Features	Lead Free Assembly
Pre-heat: Temperature Range	180°C - 200℃
Pre-heat Time (Maximum)	120 seconds
Peak Temperature	260 ℃
Soldering Time (Maximum)	10 seconds
Allowable Reflow Cycles (Max)	2

LEDS can be welded twice at most, it can be welded again after the LEDS are cooled as room temperature.

8.2CAUTION: RISK OF STATIC ELECTRICITY

1.Handling of TYF LED SMD needs countermeasures against static electricity because this is a semiconductor product. Please take adequate measures to prevent any static electricity being produced such as the wearing of a wristband or anti-static gloves when handling this product. Every manufacturing facility in regard to the product (plant, equipment, machine, carrier machine and conveyance unit) should be connected to ground and please avoid the product to be electric-charged. ESD sensitivity of this product is 2000V (HBM, based on JEITA ED-4701/304). After assembling the LEDs into your final product(s), it is recommended to check whether the assembled LEDs are damaged by static electricity (electrical leak phenomenon) or not.

2.Unit chip voltage can no higher than 5 v, chip has positive and negative pad, the chip can not light up if weld wrong.
3.Power Supply Select: This product is powered by using a constant current driver, and the output current of the power range meets the requirement of specifications book, if use constant voltage source or other conditions, please do risk assessment.

8.3 Color difference matters needing attention

The different Bin led has different photoelectric data, before use, please assess carefully.

8.4 CAUTION: TEMPERATURE CONTROL

Suggested Temperature on Tc< 85 $^{\circ}$ C and phosphor Temperature on Tc< 115 $^{\circ}$ C, if exceeded, customer needs to make reliability assessment.

8.5 CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED SMD. Please consult TYF Installation Instruction for additional information. If use the product in any of the below conditions, please confirm the reliability. Such as: wet, frost, salt air, corrosive gases (C1, H2S, where NH3, SO2, NOX); Exposure under the sun, exposure outdoor, dusty. Water, oil, liquid medical and organic solvent.

8.6 CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the LED SMD or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the LED SMD. Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area). Optical devices may be mounted on the top surface of the plastic housing of the TYF LED SMD. If LED surface is dirty, please use alcohol to clean it. Please let it dry for 2 hours before using it. Acetone or corrosive is not acceptable.

8.7 STORAGE

Storage condition: Before opening, the storage temperature should be from $5 \sim 30^{\circ}$ C, relative humidity less than 60%. (After opening the bag, LED should be used within 24H.). For unused product, please do dehumidification, vacuum sealed. Dehumidifying conditions: 60° C \pm 5°C, 24H. Effective use for the sealed products is 3 months. If it is not used up in 24 hours after opening the package, the material should be dehumidified for 3 hours under at 60° C $\pm 5^{\circ}$ C.

8.8 EYE SAFETY

Eye safety classification for the use of TYF LED SMDs is in accordance with specification IEC/TR 62778: Application of IEC 62471 for the assessment of blue light hazard to light sources and luminaires. We classify TYF LED at 660nm RG1.